

Title (en)  
THERMOELECTRIC ELEMENT

Title (de)  
THERMOELEKTRISCHES ELEMENT

Title (fr)  
ÉLÉMENT THERMOÉLECTRIQUE

Publication  
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Application  
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Abstract (en)  
A thermoelectric element according to one embodiment of the present disclosure includes a first substrate; a first insulating layer disposed on the first substrate;a plurality of first electrodes disposed on the first insulating layer;a plurality of thermoelectric legs) disposed on the plurality of first electrodes and including P type and N type semiconductors;a plurality of second electrodes disposed on the plurality of thermoelectric legs;a second insulating layer disposed on the plurality of second electrodes; anda second substrate disposed on the second insulating layer,wherein the first substrate includes a first region in which the plurality of first electrodes and the plurality of second electrodes are vertically overlapped,wherein at least one of the plurality of first electrodes includes an extension portion extending from the first region toward a first outer periphery of the first substrate,wherein a shortest distance between the first region and the first outer periphery is 1.2 to 2.5 times a shortest distance between an end of the extension portion and the first outer periphery.

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